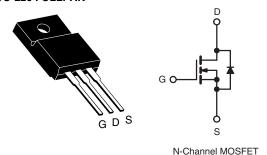
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E Series Power MOSFET

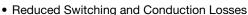
PRODUCT SUMMA	PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	650)		
$R_{DS(on)}$ max. at 25 °C (Ω) $V_{GS} = 10 \text{ V}$ 0.6				
Q _g max. (nC)	40			
Q _{gs} (nC)	5			
Q _{gd} (nC)	9			
Configuration	Sing	le		

TO-220 FULLPAK



FEATURES

- Low Figure-of-Merit (FOM) Ron x Qa
- Low Input Capacitance (Ciss)





- Ultra Low Gate Charge (Q_q)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

lote

* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF7N60E-E3

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V	600	
Drain-Source Voltage	T _C = - 25 °C	C, I _D = 250 μA	V_{DS}	575	V
Gate-Source Voltage			.,	± 20	7 °
Gate-Source Voltage AC (f > 1 Hz)			V_{GS}	30	
Continuous Drain Current (T _J = 150 °C) ^e	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	7	
	V _{GS} at 10 V	T _C = 100 °C		5	A
Pulsed Drain Current ^a			I _{DM}	18	
Linear Derating Factor				0.25	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	43	mJ
Maximum Power Dissipation			P_{D}	31	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C
Drain-Source Voltage Slope	$T_{J} = 1$	T _J = 125 °C		37	1//20
Reverse Diode dV/dt ^d			dV/dt	3	- V/ns
Soldering Recommendations (Peak Temperature)	for	10 s		300°	°C

Note

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, L = 13.8 mH, $R_g = 25 \,\Omega$, $I_{AS} = 2.5 \,\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.

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e. Limited by maximum junction temperature.

THERMAL RESISTANCE RAT	INGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	4.0	C/VV

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		609	_	_	V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J		e to 25 °C, I _D = 1 mA	-	0.68	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D = 250 μA	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
	400		= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I_{DSS}		V, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		_	0.5	0.6	Ω
Forward Transconductance	9 _{fs}		= 50 V, I _D = 3.5 A	-	1.9	-	S
Dynamic							1
Input Capacitance	C _{iss}	T	V _{GS} = 0 V,	-	680	-	
Output Capacitance	Coss		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		39	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	34	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		100	-	
Total Gate Charge	Qg			-	20	40	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 3.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	5	-	nC
Gate-Drain Charge	Q _{gd}			-	9	-	
Turn-On Delay Time	t _{d(on)}			1	13	26	
Rise Time	t _r	$V_{DD} = 480 \text{ V}, I_D = 3.5 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		1	13	26	ns
Turn-Off Delay Time	$t_{d(off)}$			ı	24	48	
Fall Time	t _f			-	14	28	
Gate Input Resistance	R_g	f = 1 MHz, open drain		ı	1.1	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	7	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	18	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	T _J = 25 °C, I _S = 3.5 A, V _{GS} = 0 V		-	1.2	V
Reverse Recovery Time	t _{rr}			-	230	_	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25$ °C, $I_F = I_S = 3.5$ A, $dI/dt = 100$ A/ μ s, $V_R = 20$ V		-	1.9	-	μC
Reverse Recovery Current	I _{RRM}			_	14	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

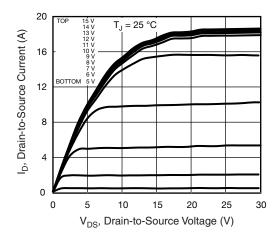


Fig. 1 - Typical Output Characteristics

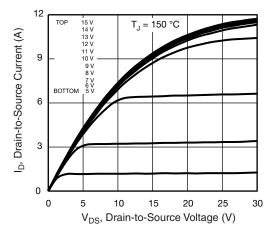


Fig. 2 - Typical Output Characteristics

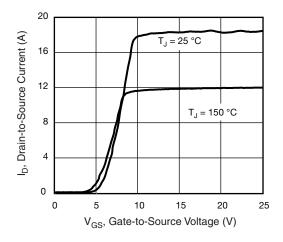


Fig. 3 - Typical Transfer Characteristics

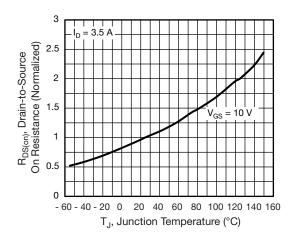


Fig. 4 - Normalized On-Resistance vs. Temperature

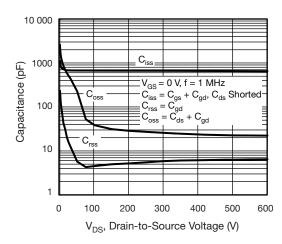


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

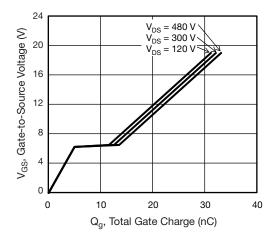


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

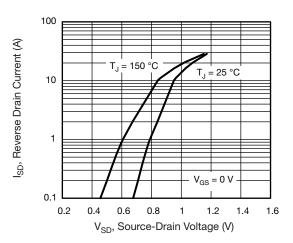


Fig. 7 - Typical Source-Drain Diode Forward Voltage

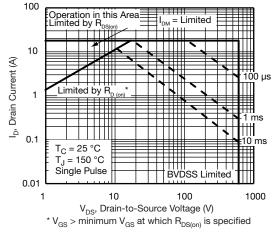


Fig. 8 - Maximum Safe Operating Area

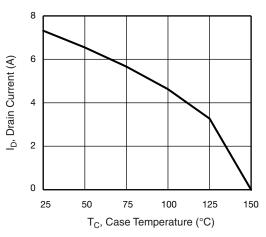


Fig. 9 - Maximum Drain Current vs. Case Temperature

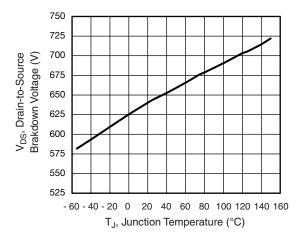


Fig. 10 - Temperature vs. Drain-to-Source Voltage

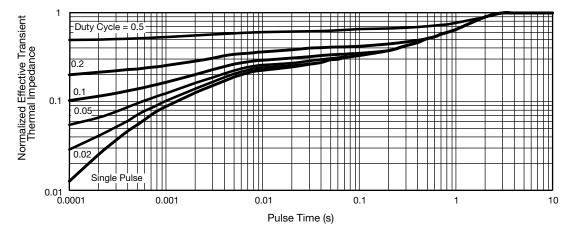


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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D.U.T. V_{DD} 10 V Pulse width $\leq 1 \mu s$ Duty factor ≤ 0.1 %

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Fig. 12 - Switching Time Test Circuit

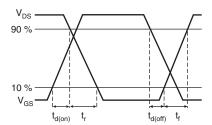


Fig. 13 - Switching Time Waveforms

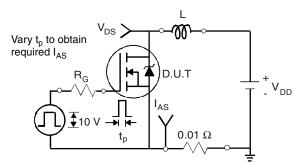


Fig. 14 - Unclamped Inductive Test Circuit

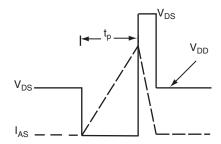


Fig. 15 - Unclamped Inductive Waveforms

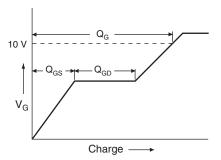


Fig. 16 - Basic Gate Charge Waveform

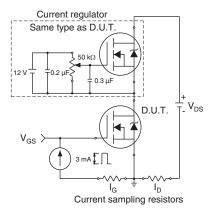
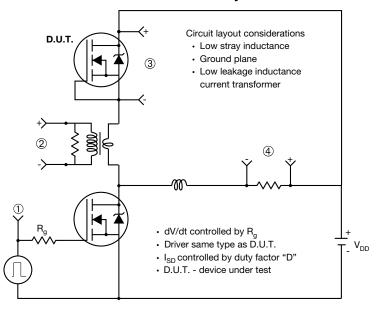


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



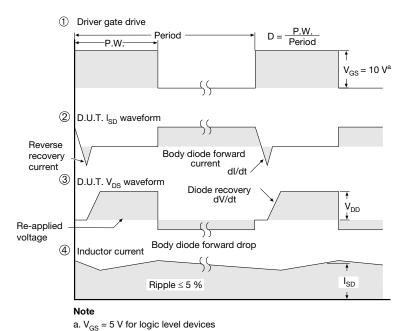
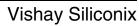


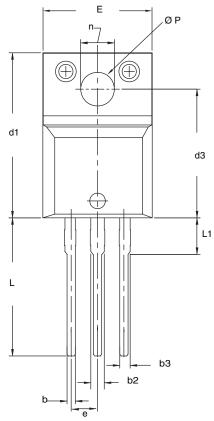
Fig. 18 - For N-Channel

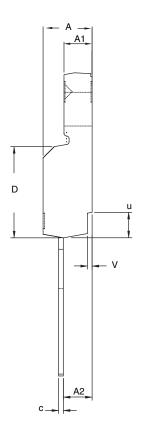
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TO-220 FULLPAK (HIGH VOLTAGE)





DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
- 4. All dimensions include burrs and plating thickness.
- 5. No chipping or package damage.

Document Number: 91359 www.vishay.com Revision: 26-Oct-09



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Revision: 02-Oct-12 Document Number: 91000